



BAS70TW /DW-04 /DW-05 /DW-06 /BRW

SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAYS

Product Summary

V _R (V)	I _F (mA)	V _{F MAX} (V) @ +25°C	I _{R MAX} (μΑ) @ +25°C
70V	1.0	0.41	0.10

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Description and Applications

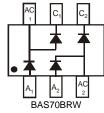
This Schottky Barrier Arrays is designed with low leakage performance in a variety of configurations. This reduces component placement costs by requiring only one component. Designed to meet AEC-Q101 requirements. Configurations are ideally suited to use as:

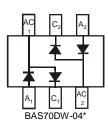
- Polarity Protection Diode
- Rail-to-Rail Data Line Protection for Two Data Lines.
- Multiplexing Circuits.
- High-efficiency, Low-current Bridge Rectifier Circuits
- · Re-circulating Diode
- Switching Diode

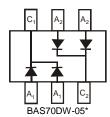
Mechanical Data

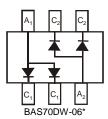
- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe). Solderable per MIL-STD-202, Method 208 © 3
- Orientation: See Diagrams Below
- Weight: 0.006 grams (Approximate)

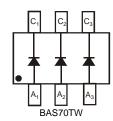












*Symmetrical configuration, no orientation indicator.

Ordering Information (Note 5)

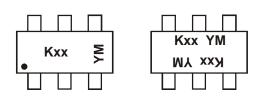
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Part Number	Compliance	Case	Packaging
BAS70DW-04-7-F	AEC-Q101	SOT-363	3000/Tape & Reel
BAS70DW-05-7-F	AEC-Q101	SOT-363	3000/Tape & Reel
BAS70DW-05Q-7-F	Automotive	SOT-363	3000/Tape & Reel
BAS70DW-06-7-F	AEC-Q101	SOT-363	3000/Tape & Reel
BAS70BRW-7-F	AEC-Q101	SOT-363	3000/Tape & Reel
BAS70TW-7-F	AEC-Q101	SOT-363	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.
- 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.



Marking Information



Kxx = Product Type Marking Code

For Symmetrical Configuration, No Orientation Indicator

K75 = BAS70BRW

K74 = BAS70DW-04

K71 = BAS70DW-05

K76 = BAS70DW-06

K73 = BAS70TW

YM = Date Code Marking

Y = Year (ex: B = 2014)

M = Month (ex: 9 = September)

Date Code Key

Year	2001	2002	2003	2004	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023
Code	M	N	0	Р	Α	В	С	D	Е	F	G	Н	I	J	K
Month	Jan	Fe	b	Mar	Apr	May	Jui	1	Jul	Aug	Sep	Oct	: 1	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D

Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	70	٧
RMS Reverse Voltage	V _{R(RMS)}	49	V
Forward Continuous Current (Note 1)	I _{FM}	70	mA
Non-Repetitive Peak Forward Surge Current @ t < 1.0s	I _{FSM}	100	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J T _{STG}	-55 to +125 -65 to +125	°C

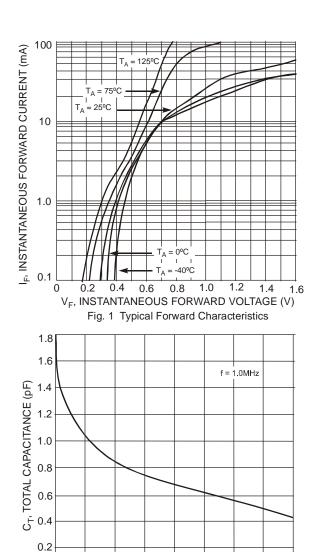
Electrical Characteristics @T_A = +25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	70	_	V	$I_R = 10\mu A$
Forward Voltage	V _F	_	410 1000		$t_p < 300 \mu s$, $I_F = 1.0 mA$ $t_p < 300 \mu s$, $I_F = 15 mA$
Reverse Current (Note 2)	I _R	_	100	nA	$t_p < 300 \mu s, V_R = 50 V$
Total Capacitance	C _T	_	2.0	pF	$V_R = 0V$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	5.0	ns	$I_F = I_R = 10 \text{mA} \text{ to } I_R = 1.0 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

- $\hbox{6. Short duration pulse test used to minimize self-heating effect.}\\$
- 7. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.





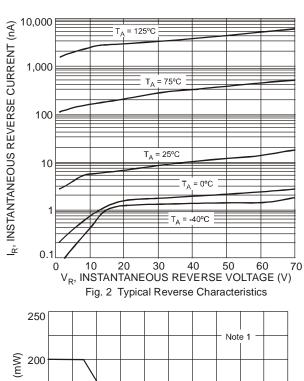
15

20

 $\mathrm{V_{R}},\,\mathrm{DC}\,\,\mathrm{REVERSE}\,\,\mathrm{VOLTAGE}\,\,\mathrm{(V)}$

Fig. 3 Total Capacitance vs. Reverse Voltage

25



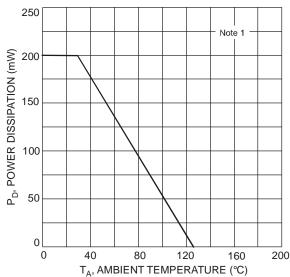


Fig. 4 Power Derating Curve, Total Package

0

0

35

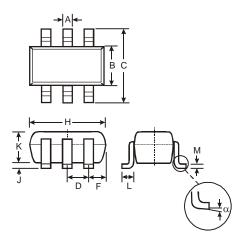
40

30



Package Outline Dimensions

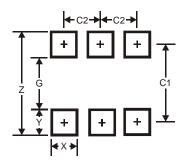
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT363						
Dim	Min	Max	Тур				
Α	0.10	0.30	0.25				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	0.65 Typ						
F	0.40	0.45	0.425				
Н	1.80	2.20	2.15				
J	0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.22	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65





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